

10-15-01

BOX NEW APPLICATION  
COMMISSIONER OF PATENTS AND TRADEMARKS  
WASHINGTON, D.C. 20231

A

Attorney Docket No. P-3641.163

NEW APPLICATION TRANSMITTAL

Transmitted herewith for filing is the new patent application of

Inventors: Cheng-Ho HSU, Yi-Hua CHANG, and Jen-Cheng LIU  
For: SEMICONDUCTOR PACKAGING STRUCTURE

Enclosed are:

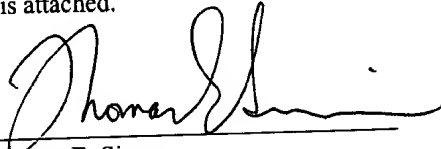
- [ x ] 14 Pages of specification, claims and abstract.  
[ x ] 8 Sheets of drawings.  
[ x ] An Assignment (with cover sheet) of the invention to Taiwan IC Packaging Corporation  
[ ] A certified copy of a \_\_\_\_\_ application.  
[ x ] Applicant claims small entity status (form enclosed).  
[ x ] Declaration and Power of Attorney For Patent Application.  
[ x ] Power of Attorney.  
[ ] Non-publication request form.  
[ ] Information Disclosure Statement By Applicant (with Form PTO-1449).  
[ x ] Acknowledgment postcard.

The filing fee has been calculated as shown below:

	Number Filed	Number Extra	Small Entity		Other Than A Small Entity	
			Rate	Fee	Rate	Fee
Basic Fee				370.		740.
Total Claims	20-20=	0	X 9.		X18.	
Indep. Claims	17-3=	0	X42.		X84.	
Multiple Dependent Claim			140.		280.	
Total				370.		

Assignment 40.  
410.

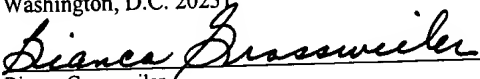
[ X ] A check in the amount of \$410 to cover the filing and assignment fees is enclosed. Any deficiency in fees should be charged to Account #07-2400. A duplicate of this transmittal is attached.

  
Thomas E. Sisson  
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Date of Deposit: 10-12-01

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Bianca Grossweiler  
3015565v1

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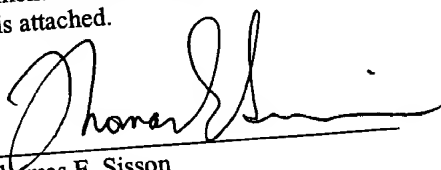
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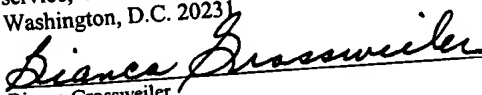
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